

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Hideyuki GOTOU	05/19/2008
Nozomi GOTOU	05/19/2008
Harunori MIYAMURA	05/19/2008

RECEIVING PARTY DATA

Name:	Daikin Industries, Ltd.
Street Address:	Umeda Center Building, 4-12,
Internal Address:	Nakazaki-Nishi 2-Chome, Kita-ku
City:	Osaka-shi, Osaka
State/Country:	JAPAN
Postal Code:	530-8323

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12601117

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	DK-US095190
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NAME OF SUBMITTER:	Patrick A. Hilsmier
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Total Attachments: 2
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**PATENT
 REEL: 023550 FRAME: 0765**

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ASSIGNMENT

[Executed in Japan]

WHEREAS, Hideyuki GOTOU, a citizen of Japan residing at c/o Rinkai Factory, Sakai Plant, DAIKIN INDUSTRIES, LTD., 12, Chikko-Shinmachi 3-cho, Nishi-ku, Sakai-shi, Osaka 592-8331 Japan

Nozomi GOTOU, a citizen of Japan residing at c/o Rinkai Factory, Sakai Plant, DAIKIN INDUSTRIES, LTD., 12, Chikko-Shinmachi 3-cho, Nishi-ku, Sakai-shi, Osaka 592-8331 Japan

Harunori MIYAMURA, a citizen of Japan residing at c/o Rinkai Factory, Sakai Plant, DAIKIN INDUSTRIES, LTD., 12, Chikko-Shinmachi 3-cho, Nishi-ku, Sakai-shi, Osaka 592-8331 Japan

hereinafter referred to as the Assignor(s), have invented certain new and useful improvements in

SCREW COMPRESSOR

for which the Assignor(s) have executed an Application for United States Letters Patent on even date herewith, AND WHEREAS,

DAIKIN INDUSTRIES, LTD.

having its principal place of business at

**Umeda Center Building, 4-12, Nakazaki-Nishi 2-Chome,
Kita-ku, Osaka-shi, Osaka 530-8323 JAPAN**

(hereinafter referred to as the Assignee), is desirous of acquiring the entire right, title, and interest in and to said invention and said Application and in and to any Letters Patent or Patents, United States or foreign as indicated below, to be obtained therefor and thereon:

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is herewith acknowledged, the Assignor(s) sell, assign, and transfer, unto the Assignee, its successors, legal representatives and assigns, the entire right, title, and interest in the United States of America, and in all foreign countries including, but not limited to, the following countries,

in, to and under said improvements, and said Application, and all original, divisional, renewal, continuation, substitute, or reissue applications thereof, including the right to sue and recover for any past infringement, and all rights of priority from the filing of said Application; and the Assignor(s) hereby authorize and request the Commissioner of Patents and Trademarks to issue all Letters Patent on said improvements or resulting therefrom to said Assignee herein, as assignee of the entire interest therein, for the sole use and behalf of said Assignee, its successors, and assigns, to the full end of the term or terms for which Letters Patent or Patents may be granted.

Further, the Assignor(s) and their legal representatives, heirs, and assigns do hereby agree and covenant without further remuneration that they will communicate to said Assignee, its successors, legal representatives and assigns, any facts known to them respecting said improvements whenever requested, and will testify in any interferences or other legal proceeding in which any of said applications or Letters Patent may become involved, sign all lawful papers, execute and deliver all divisional, continuing, reissue and other applications for Letters Patent on said improvements and all assignments thereof to said Assignee or its legal representatives, successors, or assigns, make all rightful oaths and generally do everything necessary to assist said Assignee, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in the U.S. and said countries, the expenses incident to said applications to be borne and paid by said assignee.

IN TESTIMONY WHEREOF, the undersigned Assignor(s) have affixed their signatures.

This 19th day of May, 2008 Signature Hideyuki Gotou
Hideyuki GOTOU

This 19th day of May, 2008 Signature Nozomi Gotou
Nozomi GOTOU

This 14th day of May, 2008 Signature Harunori Miyamura
Harunori MIYAMURA